Rev. 5/30/01

DECLARATION AND POWER OF ATTORNEY FOR U.S. PATENT APPLICATION

() Original () Supplemental () Substitute (X) PCT () Design	() Origina	l () Supplemental	() Substitute	(X) PCT	() Design
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As a below named inventor, I hereby declare that: my residence, post office address and citizenship are as stated below next to my name; that I verily believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural inventors are named below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

ventor (if plural inventors are named below) of	the subject matter which is claimed and	for which a patent is sought on the	invention entitled
SUBSTRATE HOLDING AF SUBSTRATE PROCESSING		OLDING METHOD, AI	VD
f which is described and claimed in:) the attached specification, or) the specification in the application Serial No and with amendments through	No. PCT/ <u>JP2004/019681</u> , filed and the content of the above-identified spand Trademark Office all information known inted States Code, '119 (and '172 if the averalso identified below any application)	December 22, 2004 pecification, including the claims, own to me to be material to paten	as amended by a tability as defined any application(s)
COUNTRY	APPLICATION NO.	DATE OF FILING	PRIORITY CLAIMED
Japan	2003-431346	December 25, 2003	Yes
Japan .	2003-432480	December 26, 2003	Yes
nereby claim the benefit under Title 35, United atter of each of the claims of this application ragraph of Title 35, United States Code '112, ode of Federal Regulations, '1.56 which occur te of this application.	n is not disclosed in the prior United S I acknowledge the duty to disclose infor	tates application in the manner praction material to patentability as	provided by the fi defined in Title 3
APPLICATION SERIAL NO.	U.S. FILING DATE	STATUS: PATENT ABANDO	ED, PENDING, NED
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And I hereby appoint Michael R. Davis, Reg. No. 25,134; Matthew M. Jacob, Reg. No. 25,154; Warren M. Cheek, Jr., Reg. No. 33,367; Nils Pedersen, Reg. No. 33,145; Charles R. Watts, Reg. No. 33,142; and Michael S. Huppert, Reg. No. 40,268, who together constitute the firm of WENDEROTH, LIND & PONACK, L.L.P., as well as any other attorneys and agents associated with Customer No. 000513, to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith.

I hereby authorize the U.S. attorneys and agents named herein to accept and follow instructions from <u>WATANABE & HOTTA</u>, as to any action to be taken in the U.S. Patent and Trademark Office regarding this application without direct communication between the U.S. attorneys and myself. In the event of a change in the persons from whom instructions may be taken, the U.S. attorneys named herein will be so notified by me.

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000513
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I further declare that all statements made herein of my own knowledge are true, and that all statements on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

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The above application may be more particularly identified as follows:	•	
U.S. Application Serial No.	Filing	Date May 3, 2006
Applicant Reference Number GEB2624-US (PEB416)	Atty	Docket No. 2006_0622A
Title of Invention SUBSTRATE HOLDING APPARATUS, S	SUBSTRATE HOLDING METI	HOD, AND SUBSTRATE
PROCESSING APPARATUS		